



# BAS45AL

Low-leakage diode

Rev. 5 — 6 August 2010

Product data sheet

## 1. Product profile

### 1.1 General description

Epitaxial medium-speed switching diode with a low leakage current, encapsulated in a small hermetically sealed glass SOD80C Surface-Mounted Device (SMD) package.

### 1.2 Features and benefits

- Continuous reverse voltage: max. 125 V
- Repetitive peak forward current: max. 625 mA
- Low reverse current: max. 1 nA
- Switching time: typ. 1.5  $\mu$ s

### 1.3 Applications

- Low leakage current applications

### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_F$	forward current	[1]	-	-	250	mA
$V_R$	reverse voltage		-	-	125	V
$V_F$	forward voltage	$I_F = 100$ mA	-	-	1000	mV

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

## 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	 006aab040
2	anode		

[1] The marking band indicates the cathode.

### 3. Ordering information

**Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
BAS45AL	-	hermetically sealed glass surface-mounted package; 2 connectors	SOD80C

### 4. Marking

**Table 4. Marking codes**

Type number	Marking code
BAS45AL	marking band

### 5. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	125	V
$V_R$	reverse voltage		-	125	V
$I_F$	forward current		[1] -	250	mA
$I_{FRM}$	repetitive peak forward current		-	625	mA
$I_{FSM}$	non-repetitive peak forward current	square wave	[2]		
		$t_p = 1 \mu s$	-	4	A
		$t_p = 1 ms$	-	1	A
		$t_p = 1 s$	-	0.5	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25 \text{ }^\circ\text{C}$	[1] -	400	mW
$T_j$	junction temperature		-	175	$^\circ\text{C}$
$T_{stg}$	storage temperature		-65	+175	$^\circ\text{C}$

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2]  $T_j = 25 \text{ }^\circ\text{C}$  prior to surge.

## 6. Thermal characteristics

**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-t)}$	thermal resistance from junction to tie-point		-	-	300	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	375	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

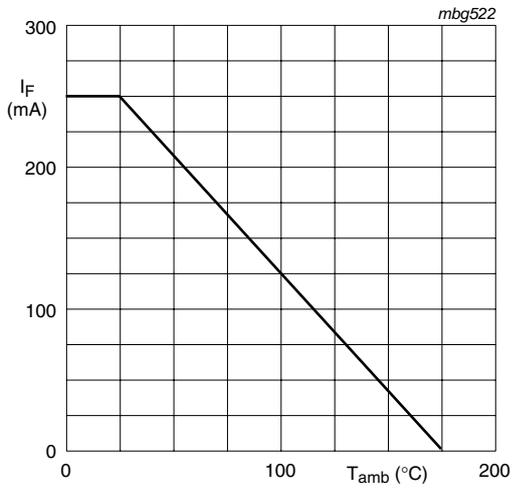
## 7. Characteristics

**Table 7. Characteristics**

$T_j = 25\text{ °C}$  unless otherwise specified.

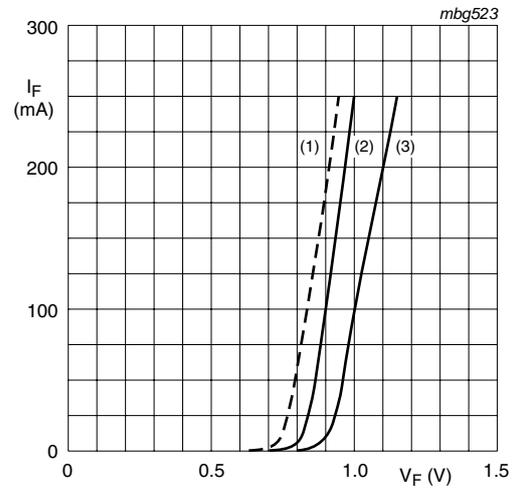
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_F$	forward voltage	$I_F = 1\text{ mA}$	-	-	780	mV
		$I_F = 10\text{ mA}$	-	-	860	mV
		$I_F = 100\text{ mA}$	-	-	1000	mV
$I_R$	reverse current	$E_{max} = 100\text{ lx}$				
		$V_R = 125\text{ V}$	-	-	1	nA
		$V_R = 30\text{ V}; T_j = 125\text{ °C}$	-	-	300	nA
		$V_R = 125\text{ V}; T_j = 125\text{ °C}$	-	-	500	nA
$C_d$	diode capacitance	$V_R = 0\text{ V}; f = 1\text{ MHz}$	-	-	4	pF
			[1]	-	1.5	-

[1] When switched from  $I_F = 10\text{ mA}$  to  $I_R = 10\text{ mA}$ ;  $R_L = 100\text{ }\Omega$ ; measured at  $I_R = 1\text{ mA}$ .



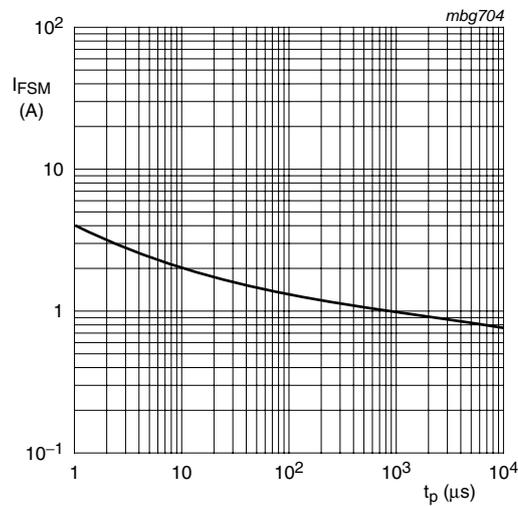
FR4 PCB, standard footprint

**Fig 1. Forward current as a function of ambient temperature; derating curve**



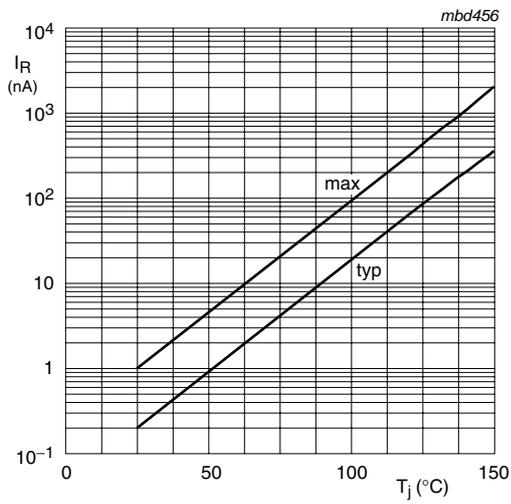
- (1) T<sub>j</sub> = 150 °C; typical values
- (2) T<sub>j</sub> = 25 °C; typical values
- (3) T<sub>j</sub> = 25 °C; maximum values

**Fig 2. Forward current as a function of forward voltage**



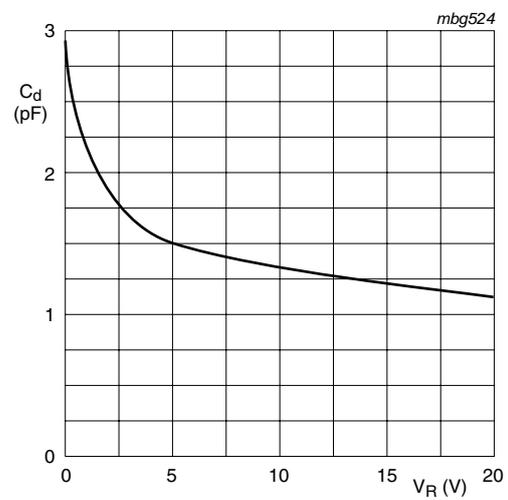
Based on square wave currents.  
T<sub>j</sub> = 25 °C prior to surge

**Fig 3. Non-repetitive peak forward current as a function of pulse duration; maximum values**



$V_R = 125\text{ V}$

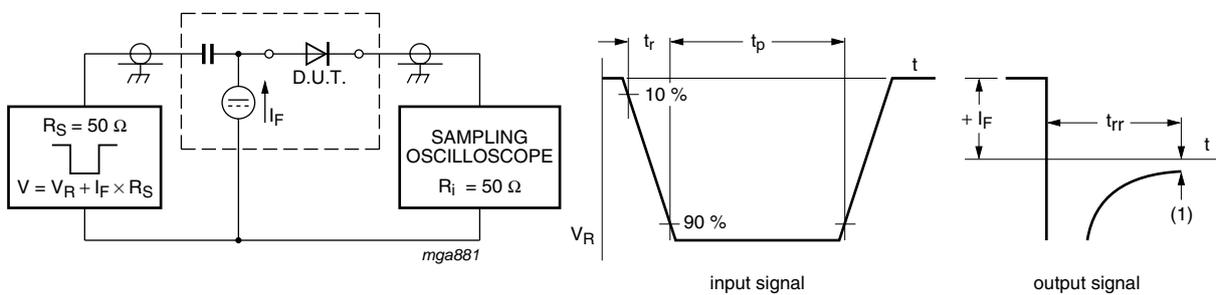
**Fig 4. Reverse current as a function of junction temperature**



$f = 1\text{ MHz}; T_j = 25\text{ °C}$

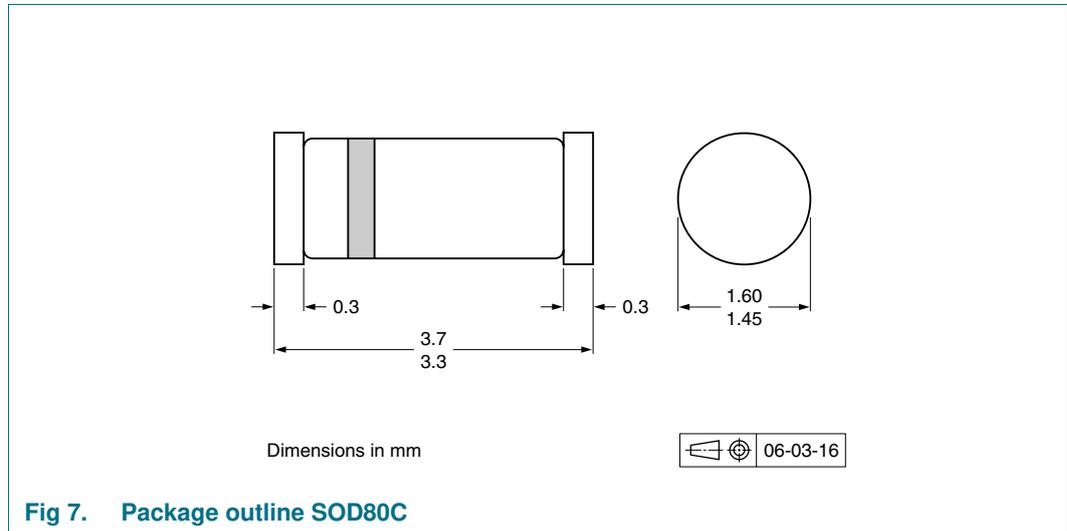
**Fig 5. Diode capacitance as a function of reverse voltage; typical values**

## 8. Test information



**Fig 6. Reverse recovery time test circuit and waveforms**

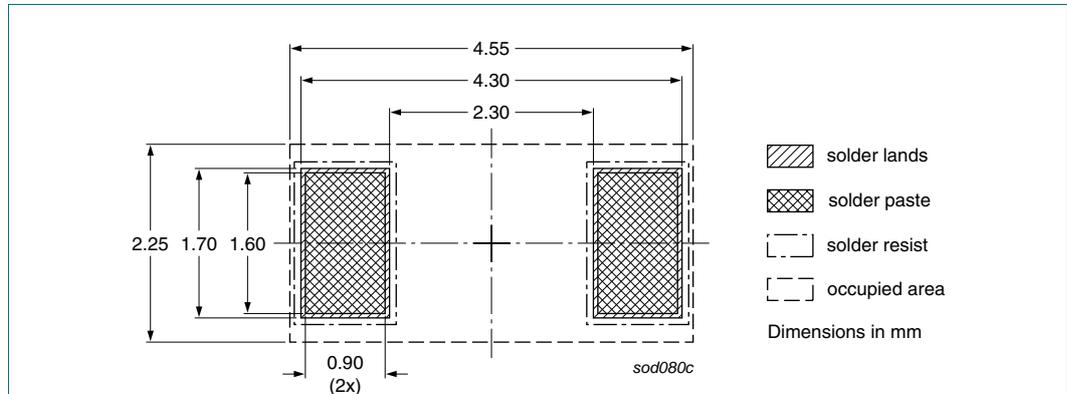
## 9. Package outline



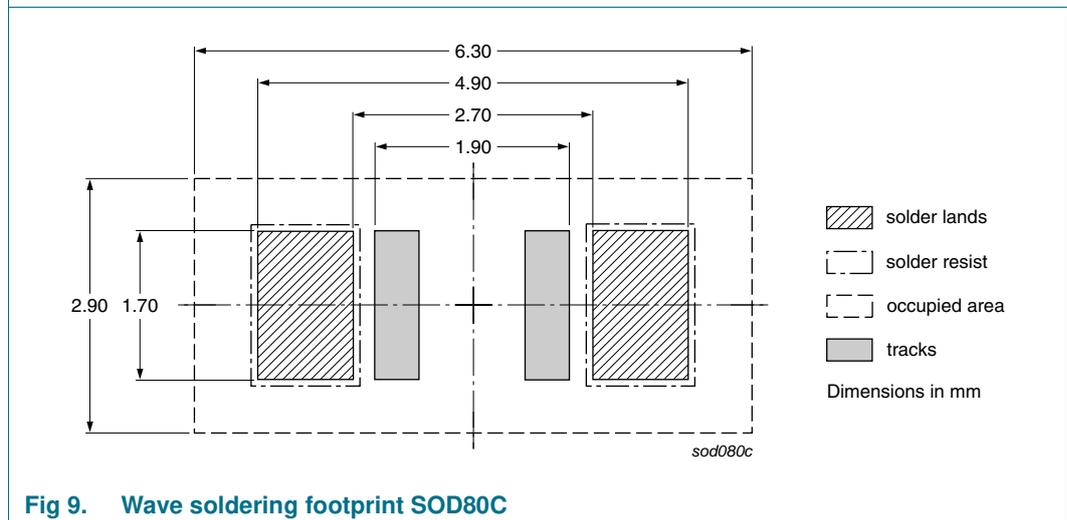
## 10. Packing information

Please refer to packing information on [www.nexperia.com](http://www.nexperia.com).

## 11. Soldering



**Fig 8. Reflow soldering footprint SOD80C**



**Fig 9. Wave soldering footprint SOD80C**

## 12. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAS45AL v.5	20100806	Product data sheet	-	BAS45AL_4
Modifications:		<ul style="list-style-type: none"><li>• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li><li>• Legal texts have been adapted to the new company name where appropriate.</li><li>• <a href="#">Table 1 “Quick reference data”</a>: added</li><li>• <a href="#">Section 4 “Marking”</a>: added</li><li>• <a href="#">Figure 7</a>: superseded by minimized package outline drawing</li><li>• <a href="#">Section 10 “Packing information”</a>: added</li><li>• <a href="#">Section 11 “Soldering”</a>: added</li><li>• <a href="#">Section 13 “Legal information”</a>: updated</li></ul>		
BAS45AL_4	19990528	Product specification	-	BAS45AL_3
BAS45AL_3	19990504	Product specification	-	BAS45AL_2
BAS45AL_2	19960313	Product specification	-	BAS45AL_1

## 13. Legal information

### 13.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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